

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: [0010441031](#)
Status: **Active**
Overview: [kk](#)
Description: 5.08mm (.200") Pitch KK® Header, Vertical, with Polarizing Backwall, 3 Circuits, Gold (Au) Plating

Documents:

[3D Model](#) [RoHS Certificate of Compliance \(PDF\)](#)
[Drawing \(PDF\)](#)

General

Product Family PCB Headers
 Series [2599](#)
 Application Wire-to-Board
 Overview [kk](#)
 Product Name KK®

Physical

Breakaway No
 Circuits (Loaded) 3
 Circuits (maximum) 3
 Color - Resin Natural
 Durability (mating cycles max) 50
 First Mate / Last Break No
 Glow-Wire Compliant No
 Guide to Mating Part No
 Keying to Mating Part None
 Lock to Mating Part None
 Material - Metal Brass
 Material - Plating Mating Gold
 Material - Plating Termination Nickel
 Material - Resin Nylon
 Number of Rows 1
 Orientation Vertical
 PC Tail Length (in) 0.175 In
 PC Tail Length (mm) 4.45 mm
 PCB Retention None
 PCB Thickness Recommended (in) 0.062 In
 PCB Thickness Recommended (mm) 1.60 mm
 Packaging Type Bag
 Pitch - Mating Interface (in) 0.200 In
 Pitch - Mating Interface (mm) 5.08 mm
 Shrouded Partial
 Stackable Yes
 Surface Mount Compatible (SMC) No
 Temperature Range - Operating 0°C to +75°C
 Termination Interface: Style Through Hole

Electrical

Current - Maximum per Contact 7A
 Voltage - Maximum 250V

Solder Process Data

Lead-free Process Capability Wave Capable (TH only)

Material Info

Old Part Number 2599-03AG

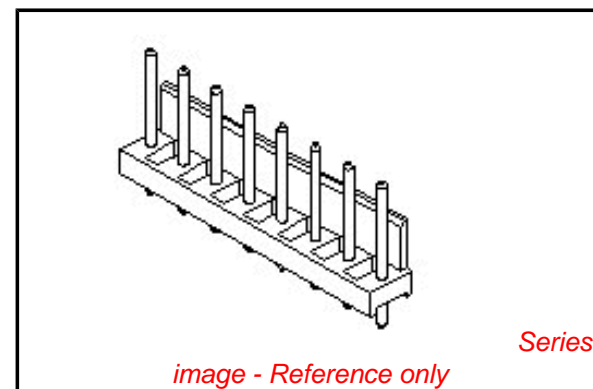


image - Reference only

EU RoHS

ELV and RoHS Compliant
REACH SVHC
 Not Reviewed
Halogen-Free Status

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
 For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

[2599Series](#)

Mates With

KK® Crimp Terminal Housing [3001](#) , [5058](#)

Reference - Drawing Numbers

Sales Drawing

SDA-2599-NAG

This document was generated on 05/24/2010

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

A-2599-NAG
 PART NO
 SEE CHART
 COMP COMP
 LOG UPDATE
 REV A
 9-12-80
 10-1-80

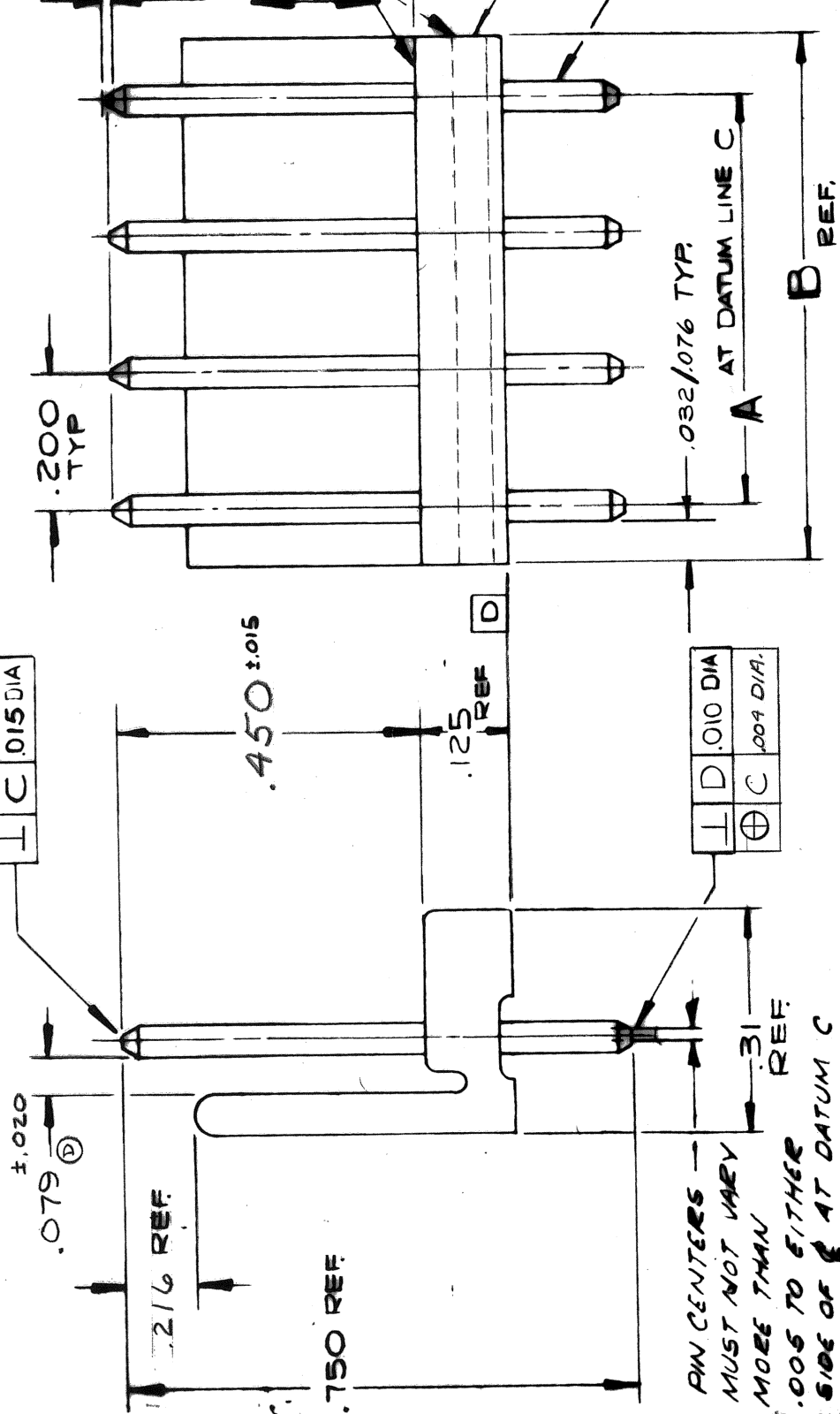
RELATIVE PIN HEIGHTS MUST NOT VARY MORE THAN .005 T.I.R.

SEE NOTE 2

.015 MAX. SAW BURR PERMITTED ON TOP & SIDE EDGES - BOTH ENDS

(N^o 2403) (WAFER)

.045 DIA. PIN, BRASS
 2173-1G
 PLATING PER ENG.
 STD. 88-501.



NOTES

- 1 PIN PUSH OUT FORCE: 3 LBS. MIN.
- 2 BURRS NOT TO EXTEND BELOW SURFACE \square
- 3 PIN MUST CONFORM TO MOLEX SOLDERABILITY SPEC. NO. 152 AFTER PLATING.

PART N ^o	ENG N ^o	N ^o OF CIRCUITS	DIM. A	DIM. B
10-44-1181	A-2599-18AG	18	3400 ± .008	2805 / 3501
10-44-1171	-17	17	3200 ± .008	3405 / 3301
10-44-1161	-16	16	3000 ± .007	3204 / 3103
10-44-1151	-15	15	2800 ± .007	3004 / 2902
10-44-1141	-14	14	2600 ± .007	2804 / 2702
10-44-1131	-13	13	2400 ± .006	2603 / 2503
10-44-1121	-12	12	2200 ± .006	2403 / 2303
10-44-1111	-11	11	2000 ± .006	2203 / 2103
10-44-1101	-10	10	1800 ± .005	2002 / 1904
10-44-1091	-9	9	1600 ± .005	1802 / 1704
10-44-1081	-8	8	1400 ± .004	1601 / 1505
10-44-1071	-7	7	1200 ± .004	1401 / 1305
10-44-1061	-6	6	1000 ± .004	1201 / 1105
10-44-1051	-5	5	800 ± .003	1000 / 906
10-44-1041	-4	4	600 ± .003	800 / 706
10-44-1031	-3	3	400 ± .002	599 / 507
10-44-1021	A-2599-2AG	2	200 ± .002	399 / 307

WAFER MATL: NYLON, PER ENG. STD. 1289.1 .200 CENTER DIA.

REV	DESCRIPTION	DATE
F	FIN. REL. -18, -17, -16, -15, -14, -13, -10, JRT	12-20-84
E	ERD 19759	
D	ECOS255	
C	ERD 13083	
B	FINAL REL. 2599-8/16	
A	ERD 12688	
-	9-12-80 GEL	

MOLEX PRODUCING WAFER ASSEMBLY

MOLEX ELECTRONIC PRODUCTS CO.

BAJH

9-12-80

A-2599-NAG